



## Film Capacitors

### Metallized Polypropylene Film Capacitors (MKP)

**Series/Type:** B32774 ... B32778

**Date:** December 2012

### Typical applications

For compact design of:

- Frequency converters
- Industrial and high-end power supplies
- Solar inverters

### Climatic

- Max. operating temperature: 105 °C (case)
- Climatic category (IEC 60068-1): 40/85/56

### Construction

- Dielectric: polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

### Features

- Capacitance values up to 110  $\mu\text{F}$
- High CV product, compact
- Excellent self-healing properties
- Overvoltage capability
- Low losses with high current capability
- High reliability
- Long useful life
- RoHS-compatible

### Terminals

- Parallel wire leads, lead-free tinned
- 2-pin and 4-pin versions
- Standard lead lengths: 6 – 1 mm
- Special lead lengths are available on request

### Marking

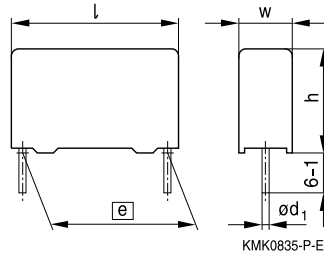
Manufacturer's logo, lot number, date code, rated capacitance (coded), capacitance tolerance (code letter), rated DC voltage

### Delivery mode

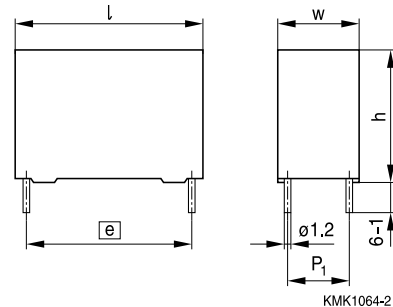
Bulk (untaped, lead length 6 – 1 mm)

### Dimensional drawings

2-pin version

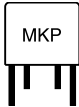


4-pin version



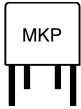
Dimensions in mm

Version	Lead spacing $[e] \pm 0.4$	Lead diameter $d_1$	Type
2-pin	27.5	0.8	B32774D
2-pin	37.5	1.0	B32776E/T
4-pin	37.5	1.2	B32776G
4-pin	52.5	1.2	B32778G



**Overview of available types**

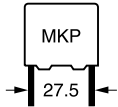
Lead spacing	27.5 mm				37.5 mm					
Type	B32774				B32776					
Page	5				6					
V <sub>R</sub> (V DC)	450	800	1100	1300	450	575	800	900	1100	1300
C <sub>R</sub> (µF)										
1.5										
2.0										
2.7										
3.0										
3.5										
3.9										
5.0										
6.8										
7.0										
7.5										
8.0										
8.5										
10										
12										
14										
15										
16										
20										
22										
25										
30										
35										
40										
45										
50										
55										
60										



**B32774 ... B32778**

**MKP DC link – high density series**

Lead spacing	52.5 mm					
Type	B32778					
Page	9					
$V_R$ (V DC)	450	575	800	900	1100	1300
$C_R$ ( $\mu$ F)						
20						
25						
27						
30						
35						
40						
45						
50						
55						
60						
75						
80						
100						
110						


**Ordering codes and packing units (lead spacing 27.5 mm)**

$C_R$	Max. dimensions $w \times h \times l$	$P_1$	Ordering code (composition see below)	$I_{RMS,max}$ 70 °C 10 kHz A	$I_{RMS,max}$ 70 °C 20 kHz A	$ESR_{typ}$ 70 °C 10 kHz mΩ	Untaped  pcs./MOQ
μF	mm	mm					
<b><math>V_{R,70\text{ °C}} = 450\text{ V DC}, V_{op,85\text{ °C}} = 450\text{ V DC}</math></b>							
5.0	11.0 × 21.0 × 31.5	–	B32774D4505+000	5.0	4.5	8.5	2352
10	15.0 × 24.5 × 31.5	–	B32774D4106+000	6.5	6.0	7.5	1680
22	22.0 × 36.5 × 31.5	–	B32774D4226+000	10.0	9.0	5.0	784
<b><math>V_{R,70\text{ °C}} = 800\text{ V DC}, V_{op,85\text{ °C}} = 700\text{ V DC}</math></b>							
3.0	11.0 × 21.0 × 31.5	–	B32774D8305+000	5.0	4.5	9.0	2352
5.0	14.0 × 24.5 × 31.5	–	B32774D8505+000	5.0	4.5	7.0	1848
12	22.0 × 36.5 × 31.5	–	B32774D8126+000	6.0	5.5	6.5	784
<b><math>V_{R,70\text{ °C}} = 1100\text{ V DC}, V_{op,85\text{ °C}} = 920\text{ V DC}</math></b>							
2.0	12.5 × 21.5 × 31.5	–	B32774D0205+000	4.0	3.5	11.0	2100
5.0	19.0 × 30.0 × 31.5	–	B32774D0505+000	6.5	6.0	7.0	896
7.0	22.0 × 36.5 × 31.5	–	B32774D0705+000	7.5	7.0	5.5	784
<b><math>V_{R,70\text{ °C}} = 1300\text{ V DC}, V_{op,85\text{ °C}} = 1100\text{ V DC}</math></b>							
1.5	12.5 × 21.5 × 31.5	–	B32774D1155+000	4.5	4.0	10.5	2100
3.0	18.0 × 27.5 × 31.5	–	B32774D1305+000	6.0	5.5	7.0	1428
5.0	22.0 × 36.5 × 31.5	–	B32774D1505+000	8.0	7.0	6.0	784

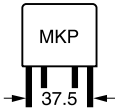
MOQ = Minimum Order Quantity, consisting of 4 packing units.  
Further E series and intermediate capacitance values on request.

**Composition of ordering code**

+ = Capacitance tolerance code:

K = ±10%

J = ±5%


**B32776**
**MKP DC link – high density series**
**Ordering codes and packing units (lead spacing 37.5 mm)**

$C_R$	Max. dimensions $w \times h \times l$	$P_1$	Ordering code (composition see below)	$I_{RMS,max}$ 70 °C 10 kHz A	$I_{RMS,max}$ 70 °C 20 kHz A	$ESR_{typ}$ 70 °C 10 kHz mΩ	Untaped  pcs./MOQ
μF	mm	mm					
<b><math>V_{R,70\text{ °C}} = 450\text{ V DC}</math>, <math>V_{op,85\text{ °C}} = 450\text{ V DC}</math></b>							
12	24.0 × 15.0 × 41.5	–	B32776T4126K000	8.0	8.0	8.0	1040
16	24.0 × 19.0 × 41.5	–	B32776T4166K000	9.0	9.0	7.0	780
30	20.0 × 39.5 × 41.5	10.2	B32776G4306+000	12.5	11.5	8.0	640
30	20.0 × 39.5 × 41.5	–	B32776E4306+000	11.5	10.5	9.0	640
35	28.0 × 37.0 × 42.0	10.2	B32776G4356+000	13.5	12.5	8.0	440
35	28.0 × 37.0 × 42.0	–	B32776E4356+000	12.5	11.5	9.0	440
40	28.0 × 37.0 × 42.0	10.2	B32776G4406+000	14.5	13.5	5.0	440
40	28.0 × 37.0 × 42.0	–	B32776E4406+000	13.5	12.5	5.5	440
50	28.0 × 42.5 × 41.5	10.2	B32776G4506+000	16.0	15.0	4.0	440
50	28.0 × 42.5 × 41.5	–	B32776E4506+000	15.0	14.0	4.0	440
60	30.0 × 45.0 × 42.0	–	B32776E4606+000	16.5	15.0	3.0	400
<b><math>V_{R,70\text{ °C}} = 575\text{ V DC}</math>, <math>V_{op,85\text{ °C}} = 500\text{ V DC}</math></b>							
8.5	24.0 × 15.0 × 41.5	–	B32776T5855+000	8.5	8.5	7.0	1040
12	24.0 × 19.0 × 41.5	–	B32776T5126K000	9.0	9.0	7.0	780
25	20.0 × 39.5 × 41.5	10.2	B32776G5256K000	11.5	11.5	4.75	640
25	20.0 × 39.5 × 41.5	–	B32776E5256K000	11.0	11.0	5.0	640
30	28.0 × 37.0 × 42.0	10.2	B32776G5306+000	14.0	14.0	3.85	440
30	28.0 × 37.0 × 42.0	–	B32776E5306+000	13.5	13.5	4.0	440
35	28.0 × 42.5 × 41.5	10.2	B32776G5356+000	14.5	14.0	3.75	440
35	28.0 × 42.5 × 41.5	–	B32776E5356+000	14.0	13.5	4.0	440
45	30.0 × 45.0 × 42.0	20.3	B32776G5456K000	16.5	16.5	2.85	400
45	30.0 × 45.0 × 42.0	–	B32776E5456K000	15.5	15.0	3.4	400
55	33.0 × 48.0 × 42.0	20.3	B32776G5556K000	19.0	19.0	2.4	180

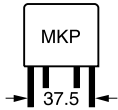
MOQ = Minimum Order Quantity, consisting of 4 packing units.  
Further E series and intermediate capacitance values on request.

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+ = Capacitance tolerance code:

K = ±10%

J = ±5%


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μF	mm	mm					
<b><math>V_{R,70\text{ °C}} = 800\text{ V DC}</math>, <math>V_{op,85\text{ °C}} = 700\text{ V DC}</math></b>							
6.8	24.0 × 15.0 × 41.5	–	B32776T8685+000	7.0	7.0	11.0	1040
8.5	24.0 × 19.0 × 41.5	–	B32776T8855+000	8.0	8.0	9.0	780
14	18.0 × 32.5 × 41.5	–	B32776E8146+000	10.0	9.0	7.5	720
15	20.0 × 39.5 × 41.5	10.2	B32776G8156+000	10.5	9.5	7.0	640
20	28.0 × 37.0 × 42.0	10.2	B32776G8206+000	12.0	11.0	5.5	440
20	28.0 × 37.0 × 42.0	–	B32776E8206+000	11.5	10.5	6.5	440
22	28.0 × 37.0 × 42.0	10.2	B32776G8226+000	13.0	12.0	5.0	440
25	28.0 × 42.5 × 41.5	–	B32776E8256+000	13.5	12.5	4.5	440
30	30.0 × 45.0 × 42.0	20.3	B32776G8306+000	15.0	14.0	3.5	400
30	30.0 × 45.0 × 42.0	–	B32776E8306+000	14.0	13.0	5.0	400
<b><math>V_{R,70\text{ °C}} = 900\text{ V DC}</math>, <math>V_{op,85\text{ °C}} = 800\text{ V DC}</math></b>							
5	24.0 × 15.0 × 41.5	–	B32776T9505+000	4.5	4.5	17.0	1040
7.5	24.0 × 19.0 × 41.5	–	B32776T9755K000	6.0	6.0	12.0	780
15	20.0 × 39.5 × 41.5	10.2	B32776G9156K000	10.5	10.5	6.15	640
15	20.0 × 39.5 × 41.5	–	B32776E9156K000	10.0	10.0	6.35	640
20	28.0 × 37.0 × 42.0	10.2	B32776G9206K000	12.5	12.5	4.7	440
20	28.0 × 37.0 × 42.0	–	B32776E9206K000	12.0	12.0	4.9	440
22	28.0 × 42.5 × 41.5	10.2	B32776G9226K000	13.0	13.0	4.3	440
22	28.0 × 42.5 × 41.5	–	B32776E9226K000	12.5	12.0	4.8	440
25	30.0 × 45.0 × 42.0	20.3	B32776G9256+000	15.0	14.5	3.8	400
25	30.0 × 45.0 × 42.0	–	B32776E9256+000	14.0	13.5	4.2	400
30	33.0 × 48.0 × 42.0	20.3	B32776G9306+000	17.0	16.5	2.85	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.

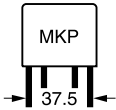
Further E series and intermediate capacitance values on request.

**Composition of ordering code**

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K = ±10%

J = ±5%


**B32776**
**MKP DC link – high density series**
**Ordering codes and packing units (lead spacing 37.5 mm)**

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μF	mm	mm					
<b><math>V_{R,70\text{ °C}} = 1100\text{ V DC}</math>, <math>V_{op,85\text{ °C}} = 920\text{ V DC}</math></b>							
3.9	24.0 × 15.0 × 41.5	–	B32776T0395+000	6.5	6.5	12.0	1040
5	24.0 × 19.0 × 41.5	–	B32776T0505+000	7.0	7.0	10.0	780
12	20.0 × 39.5 × 41.5	10.2	B32776G0126+000	11.0	10.0	6.5	640
12	20.0 × 39.5 × 41.5	–	B32776E0126+000	10.0	9.0	7.0	640
14	28.0 × 37.0 × 42.0	10.2	B32776G0146+000	13.0	12.0	5.5	440
14	28.0 × 37.0 × 42.0	–	B32776E0146+000	12.0	11.0	6.0	440
16	28.0 × 42.5 × 41.5	10.2	B32776G0166+000	13.0	12.0	5.0	440
16	28.0 × 42.5 × 41.5	–	B32776E0166+000	12.0	11.0	5.5	440
20	30.0 × 45.0 × 42.0	20.3	B32776G0206+000	15.0	13.0	3.0	400
20	30.0 × 45.0 × 42.0	–	B32776E0206+000	13.0	12.0	3.5	400
<b><math>V_{R,70\text{ °C}} = 1300\text{ V DC}</math>, <math>V_{op,85\text{ °C}} = 1100\text{ V DC}</math></b>							
2.7	24.0 × 15.0 × 41.5	–	B32776T1275+000	6.0	6.0	16.0	1040
3.5	24.0 × 19.0 × 41.5	–	B32776T1355+000	6.5	6.5	13.0	780
8.0	20.0 × 39.5 × 41.5	10.2	B32776G1805+000	9.0	8.0	8.0	640
10	28.0 × 37.0 × 42.0	10.2	B32776G1106+000	12.0	11.0	6.5	440
10	28.0 × 37.0 × 42.0	–	B32776E1106+000	11.0	10.0	7.0	440
12	28.0 × 42.5 × 41.5	10.2	B32776G1126+000	13.0	12.0	5.5	440
14	30.0 × 45.0 × 42.0	–	B32776E1146+000	13.0	12.0	5.0	400

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

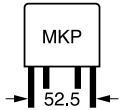
**Composition of ordering code**

+ = Capacitance tolerance code:

K = ±10%

J = ±5%




**Ordering codes and packing units (lead spacing 52.5 mm)**

$C_R$	Max. dimensions $w \times h \times l$	$P_1$	Ordering code (composition see below)	$I_{RMS,max}$ 70 °C 10 kHz A	$I_{RMS,max}$ 70 °C 20 kHz A	$ESR_{typ}$ 70 °C 10 kHz mΩ	Untaped  pcs./MOQ
μF	mm	mm					
<b><math>V_{R,70\text{ °C}} = 450\text{ V DC}, V_{op,85\text{ °C}} = 450\text{ V DC}</math></b>							
75	30.0 × 45.0 × 57.5	20.3	B32778G4756+000	16.0	15.5	5.5	280
80	30.0 × 45.0 × 57.5	20.3	B32778G4806+000	16.5	16.0	5.0	280
100	35.0 × 50.0 × 57.5	20.3	B32778G4107+000	18.0	18.0	4.0	108
110	35.0 × 50.0 × 57.5	20.3	B32778G4117+000	19.0	19.0	4.0	108
<b><math>V_{R,70\text{ °C}} = 575\text{ V DC}, V_{op,85\text{ °C}} = 500\text{ V DC}</math></b>							
60	30.0 × 45.0 × 57.5	20.3	B32778G5606+000	16.0	15.5	3.5	280
80	35.0 × 50.0 × 57.5	20.3	B32778G5806+000	19.0	18.5	3.0	108
<b><math>V_{R,70\text{ °C}} = 800\text{ V DC}, V_{op,85\text{ °C}} = 700\text{ V DC}</math></b>							
45	30.0 × 45.0 × 57.5	20.3	B32778G8456+000	16.0	15.0	4.0	280
55	35.0 × 50.0 × 57.5	20.3	B32778G8556+000	17.0	16.0	3.5	108
60	35.0 × 50.0 × 57.5	20.3	B32778G8606+000	19.0	18.0	3.0	108
<b><math>V_{R,70\text{ °C}} = 900\text{ V DC}, V_{op,85\text{ °C}} = 800\text{ V DC}</math></b>							
35	30.0 × 45.0 × 57.5	20.3	B32778G9356+000	14.0	14.0	4.5	280
50	35.0 × 50.0 × 57.5	20.3	B32778G9506K000	18.0	18.0	3.5	108
<b><math>V_{R,70\text{ °C}} = 1100\text{ V DC}, V_{op,85\text{ °C}} = 920\text{ V DC}</math></b>							
30	30.0 × 45.0 × 57.5	20.3	B32778G0306+000	16.0	14.0	5.0	280
40	35.0 × 50.0 × 57.5	20.3	B32778G0406+000	20.0	20.0	3.5	108
<b><math>V_{R,70\text{ °C}} = 1300\text{ V DC}, V_{op,85\text{ °C}} = 1100\text{ V DC}</math></b>							
20	30.0 × 45.0 × 57.5	20.3	B32778G1206+000	14.0	13.0	5.5	280
25	35.0 × 50.0 × 57.5	20.3	B32778G1256+000	17.0	16.0	4.5	108
27	35.0 × 50.0 × 57.5	20.3	B32778G1276+000	17.5	16.0	4.5	108

MOQ = Minimum Order Quantity, consisting of 4 packing units.  
Further E series and intermediate capacitance values on request.

**Composition of ordering code**

+ = Capacitance tolerance code:

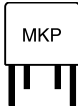
K = ±10%

J = ±5%


**Technical data**

 Reference standard: IEC 61071. All data given at  $T = 20\text{ °C}$ , unless otherwise specified.

Operating temperature range (case)		Max. operating temperature, $T_{op,max}$	+105 °C	
		Upper category temperature $T_{max}$	+85 °C	
		Lower category temperature $T_{min}$	-40 °C	
ESR (at 10 kHz)	LS 27.5	$< 3.0 \cdot ESR_{typ}$		
	LS 37.5	$< 2.5 \cdot ESR_{typ}$		
	LS 52.5	$< 2.0 \cdot ESR_{typ}$		
Insulation Resistance $R_{ins}$ given as time constant $\tau = C_R \cdot R_{ins}$ , rel. humidity $\leq 65\%$ (minimum as-delivered values)		30 000 s		
DC test voltage between terminals (10 s)		$1.5 \cdot V_R$		
DC test voltage terminal to case (10 s)		2110 V AC, 50 Hz		
Maximum peak current (A)		$I_{p,max} = C_R \cdot \frac{dV}{dt}$		
Damp heat test		56 days/40 °C/93% relative humidity		
Limit values after damp heat test		Capacitance change $ \Delta C/C $	$\leq 5\%$	
		Dissipation factor change $\Delta \tan \delta$	$\leq 1.5 \cdot 10^{-3}$ (at 1 kHz)	
		Insulation resistance $R_{ins}$	$\geq 50\%$ of minimum as-delivered values	
Reliability:	Failure rate $\lambda$	50 fit ( $\leq 1 \cdot 10^{-9}/h$ ) at $0.5 \cdot V_R$ , 40 °C		
	Service life $t_{sl}$	100 000 h at $V_R$ and 70 °C		
		For conversion to other operating conditions, refer to chapter "Quality, 2 Reliability".		
$V_R$ (V DC)		450	575    800    900    1100    1300	
Continuous operation voltage $V_{op}$ (V DC) at 70 °C		450	575    800    900    1100    1300	
Continuous operation voltage $V_{op}$ (V DC) at 85 °C		450	500    700    800    920    1100	
For temperatures between 70 °C and 85 °C		1%/°C of derating respect $V_{op}$ at 70 °C (no derating at 450 V DC series)		



### Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/ $\mu$ s.

Note:

The values of dV/dt provided below must not be exceeded in order to avoid damaging the capacitor.

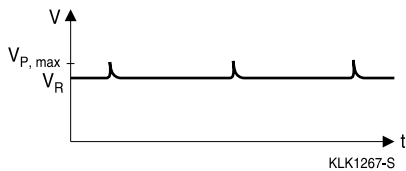
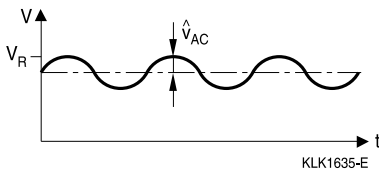
#### dV/dt values

Lead spacing	27.5 mm				37.5 mm					
Type	B32774				B32776					
V <sub>R</sub> (V DC)	450	800	1100	1300	450	575	800	900	1100	1300
dV/dt in V/ $\mu$ s	30	40	75	100	21	22	22	32	54	73

Lead spacing	52.5 mm					
Type	B32778					
V <sub>R</sub> (V DC)	450	575	800	900	1100	1300
dV/dt in V/ $\mu$ s	14	15	15	25	35	50


**B32774 ... B32778**
**MKP DC link – high density series**
**ESL values**

		ESL
2-pin	B32774D	25 nH
	B32776E	10 nH
4-pin	B32776G	15 nH
	B32778G	15 nH

**Typical waveforms**

**Restrictions:**

**$V_R$ :** Maximum operating peak voltage of either polarity but of a non-reversing waveform, for which the capacitor has been designed for continuous operation.

$$\hat{V}_{AC} \leq 0.2 \cdot V_R$$

**$V_{P,max}$ :** Maximum permissible recurrent voltage that may appear for 2% of the period.

## Mounting guidelines

### 1 Soldering

#### 1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/–0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder

#### 1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A.

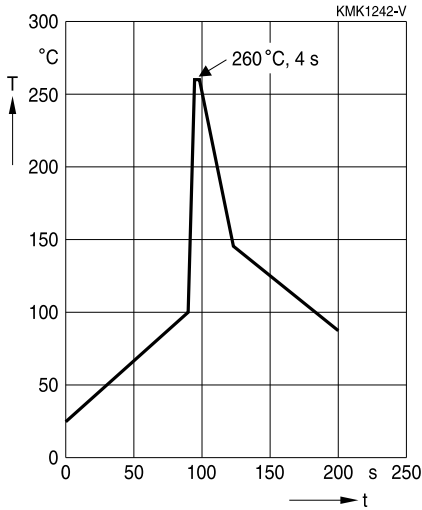
Conditions:

Series	Solder bath temperature	Soldering time
MKT boxed (except 2.5 × 6.5 × 7.2 mm) coated uncoated (lead spacing > 10 mm)	260 ±5 °C	10 ±1 s
MFP MKP (lead spacing > 7.5 mm)		
MKT boxed (case 2.5 × 6.5 × 7.2 mm)		5 ±1 s
MKP (lead spacing ≤ 7.5 mm)		< 4 s
MKT uncoated (lead spacing ≤ 10 mm) insulated (B32559)		recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559)



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Immersion depth	2.0 +0/−0.5 mm from capacitor body or seating plane
Shield	Heat-absorbing board, (1.5 ±0.5) mm thick, between capacitor body and liquid solder
Evaluation criteria:	
Visual inspection	No visible damage
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors
$\tan \delta$	As specified in sectional specification

### 1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature  $T_{max}$ . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
  - diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

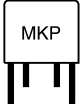
EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
  - MKP/MFP 110 °C
  - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

#### Uncoated capacitors

For uncoated MKT capacitors with lead spacings  $\leq 10$  mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering



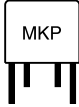
### Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"

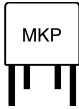




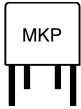
Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"


**Symbols and terms**

Symbol	English	German
$\alpha$	Heat transfer coefficient	Wärmeübergangszahl
$\alpha_C$	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
A	Capacitor surface area	Kondensatoroberfläche
$\beta_C$	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
C	Capacitance	Kapazität
$C_R$	Rated capacitance	Nennkapazität
$\Delta C$	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
$\Delta t$	Time interval	Zeitintervall
$\Delta T$	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta \tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
$\Delta V$	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
$f_1$	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
$f_2$	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
$f_r$	Resonant frequency	Resonanzfrequenz
$F_D$	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
$F_T$	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
$I_C$	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)



Symbol	English	German
$I_{RMS}$	(Sinusoidal) alternating current, root-mean-square value	(Sinusförmiger) Wechselstrom
$i_z$	Capacitance drift	Inkonstanz der Kapazität
$k_0$	Pulse characteristic	Impuls Kennwert
$L_S$	Series inductance	Serieninduktivität
$\lambda$	Failure rate	Ausfallrate
$\lambda_0$	Constant failure rate during useful service life	Konstante Ausfallrate in der Nutzungsphase
$\lambda_{test}$	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
$P_{diss}$	Dissipated power	Abgegebene Verlustleistung
$P_{gen}$	Generated power	Erzeugte Verlustleistung
$Q$	Heat energy	Wärmeenergie
$\rho$	Density of water vapor in air	Dichte von Wasserdampf in Luft
$R$	Universal molar constant for gases	Allg. Molarkonstante für Gas
$R$	Ohmic resistance of discharge circuit	Ohmscher Widerstand des Entladekreises
$R_i$	Internal resistance	Innenwiderstand
$R_{ins}$	Insulation resistance	Isolationswiderstand
$R_P$	Parallel resistance	Parallelwiderstand
$R_S$	Series resistance	Serienwiderstand
$S$	severity (humidity test)	Schärfegrad (Feuchtestest)
$t$	Time	Zeit
$T$	Temperature	Temperatur
$\tau$	Time constant	Zeitkonstante
$\tan \delta$	Dissipation factor	Verlustfaktor
$\tan \delta_D$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
$\tan \delta_P$	Parallel component of dissipation factor	Parallelanteil des Verlustfaktors
$\tan \delta_S$	Series component of dissipation factor	Serienanteil des Verlustfaktors
$T_A$	Ambient temperature	Umgebungstemperatur
$T_{max}$	Upper category temperature	Obere Kategorietemperatur
$T_{min}$	Lower category temperature	Untere Kategorietemperatur
$t_{OL}$	Operating life at operating temperature and voltage	Betriebszeit bei Betriebstemperatur und -spannung
$T_{op}$	Operating temperature	Betriebstemperatur
$T_R$	Rated temperature	Nenntemperatur
$T_{ref}$	Reference temperature	Referenztemperatur
$t_{SL}$	Reference service life	Referenz-Lebensdauer
$V_{AC}$	AC voltage	Wechselspannung


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Symbol	English	German
$V_C$	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige) Kategorie-Wechselspannung
$V_{CD}$	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
$V_{ch}$	Charging voltage	Ladespannung
$V_{DC}$	DC voltage	Gleichspannung
$V_{FB}$	Fly-back capacitor voltage	Spannung (Flyback)
$V_i$	Input voltage	Eingangsspannung
$V_o$	Output voltage	Ausgangssspannung
$V_{op}$	Operating voltage	Betriebsspannung
$V_p$	Peak pulse voltage	Impuls-Spitzenspannung
$V_{pp}$	Peak-to-peak voltage Impedance	Spannungshub
$V_R$	Rated voltage	Nennspannung
$\hat{V}_R$	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
$V_{RMS}$	(Sinusoidal) alternating voltage, root-mean-square value	(Sinusförmige) Wechselspannung
$V_{SC}$	S-correction voltage	Spannung bei Anwendung "S-correction"
$V_{sn}$	Snubber capacitor voltage	Spannung bei Anwendung "Beschaltung"
$Z$	Impedance	Scheinwiderstand
$e$	Lead spacing	Rastermaß

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